

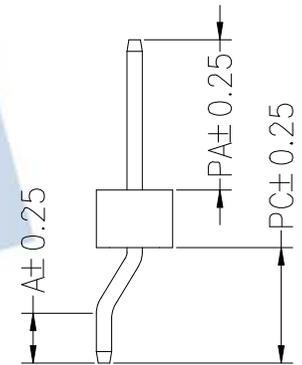
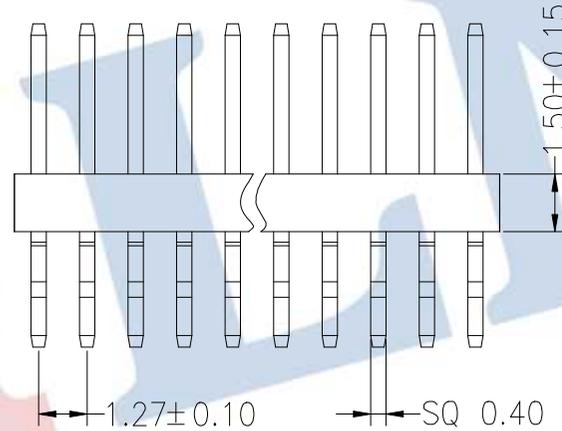
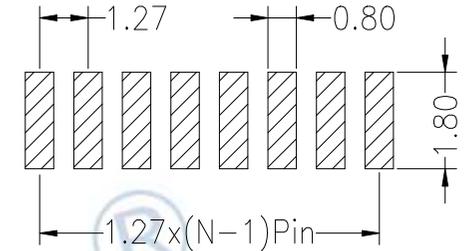
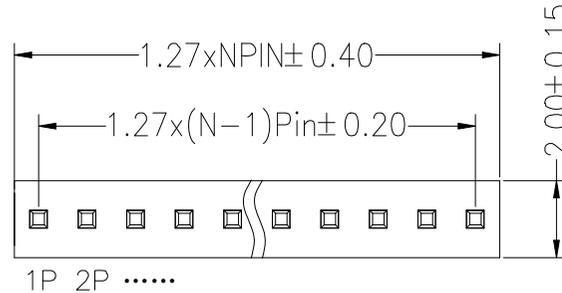


**SPECIFICATIONS**

Rated Current:1.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°C to +105°C

Contact Material:Brass  
 Contact Plating:Au Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Resistance To Soldering Heat:  
 260° C±5° C, 10s(PA6T&PA9T&LCP insulator)

Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

**1415 1 1 XX X N XX Z XXX X 0X**

- High.of Plastic 15=H1.5mm
- No.of Pins Per Row 02~50P
- Insulator Material Option C=BK-PA6T E=BK-PA9T F=BK-LCP
- Contact Plating G0:Gold Flash G1:1u" Gold G2:1.5u" Gold G3:2u" Gold G4:3u" Gold G5:5u" Gold G6:10u" Gold G7:15u" Gold G8:30u" Gold S0:Gold Flash/Tin SN:Tin
- Pin Length
- Packing O=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar

Dimension antitheses list			
ITEM	PA	A	PC
Standard	XXX	XXX	XXX

				OPERATION		DRAW	RICH LIN	23.06.10	SCALE	FIT	<b>JILN</b> ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5992	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK	SIZE	A4				
A0	2023.06.10	NEW DRAWING		X.XXX	±0.10	APPROVE	SHEET	1/1				
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL	PROJ.		TITLE:	1.27mm Pin Header 90° SMT 平面胶芯		